

FEATURES

- **Member of the Texas Instruments** Widebus™ Familv
- Dynamic Output Control (DOC[™]) Circuitry **Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed** Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With I_{OH} and I_{OL} of ±24 mA at 2.5-V V_{CC}
- Control Inputs VIH/VIL Levels are Referenced to V_{CCB} Voltage
- If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- **Overvoltage-Tolerant Inputs/Outputs Allow** Mixed-Voltage-Mode Data Communications

- Ioff Supports Partial-Power-Down Mode Operation **Fully Configurable Dual-Rail Design Allows**
- Each Port to Operate Over the Full 1.4-V to 3.6-V Power-Supply Range
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A-port is designed to track V_{CCA}. V_{CCA} accepts any supply voltage from 1.4 V to 3.6 V. The B-port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCBH164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCBH164245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCB}.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CCB} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using loff. The loff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either V_{CC} input is at GND, both ports are in the high-impedance state.

| T _A | PACKAGE ⁽¹⁾⁽²⁾ C | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------------------------|---------------|-----------------------|------------------|
| | TSSOP – DGG | Tape and reel | SN74AVCBH164245GR | AVCBH164245 |
| 10°C to 95°C | TVSOP – DGV | Tape and reel | SN74AVCBH164245VR | WBH4245 |
| –40°C to 85°C | VFBGA – GQL | Tape and reel | SN74AVCBH164245KR | WBH4245 |
| | VFBGA – ZQL (Pb-free) | Tape and reel | SN74AVCBH164245ZQLR | WBH4245 |

ORDERING INFORMATION

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2)For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



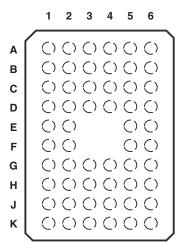
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TERMINAL ASSIGNMENTS

| DGG (| OR DGV (TOP V | | KAGE |
|--|---|--|---------------------------------|
| 1DIR [1BI [1B2 [GND [1B3 [1B4 [V _{CCB} [1B5 [1B6 [GND [2B1 [2B2 [GND [2B3 [2B4 [V _{CCB} [2B5 [2B6 [GND [2B7 [2B7] | (TOP V 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 | 48 47 46 45 44 43 42 41 40 39 38 37 | 10E 1A1 1A2 GND 1A3 |
| 2B8 [2DIR [| 23 24 | 26 25 | 2A8 2OE |
| | | | |

GQL/ZQL PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS (56-Ball GQL/ZQL Package)⁽¹⁾

| | 1 | 2 | 3 4 | | 5 | 6 |
|---|------|-----|------------------|------------------|-----|-------------------|
| Α | 1DIR | NC | NC | NC NC | | 1 0E |
| В | 1B2 | 1B1 | GND | GND | 1A1 | 1A2 |
| С | 1B4 | 1B3 | V _{CCB} | V _{CCA} | 1A3 | 1A4 |
| D | 1B6 | 1B5 | GND | GND | 1A5 | 1A6 |
| Е | 1B8 | 1B7 | | | 1A7 | 1A8 |
| F | 2B1 | 2B2 | | | 2A2 | 2A1 |
| G | 2B3 | 2B4 | GND | GND | 2A4 | 2A3 |
| н | 2B5 | 2B6 | V _{CCB} | V _{CCA} | 2A6 | 2A5 |
| J | 2B7 | 2B8 | GND | GND | 2A8 | 2A7 |
| к | 2DIR | NC | NC | NC | NC | 2 <mark>0E</mark> |

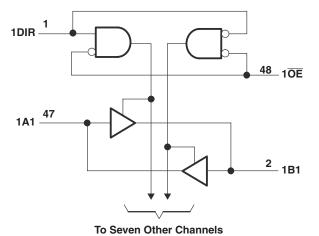
(1) NC - No internal connection

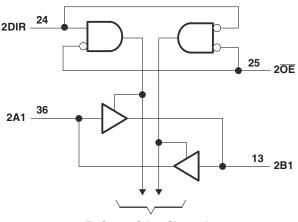


FUNCTION TABLE (EACH 8-BIT SECTION)

| INP | UTS | OPERATION |
|-----|-----|-----------------|
| ŌĒ | DIR | OPERATION |
| L | L | B data to A bus |
| L | Н | A data to B bus |
| н | Х | Isolation |

LOGIC DIAGRAM (POSITIVE LOGIC)





To Seven Other Channels

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------------------------|---|--------------------|------|------------------------|------|
| V _{CCA} V _{CCB} | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| VI | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| | Voltage range applied to any output in the high-impedance or | A port | -0.5 | 4.6 | V |
| Vo | Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾ | B port | -0.5 | 4.6 | V |
| \ <i>\</i> | Valte as reaching the set output in the high on law state $\binom{2}{3}$ | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state $^{(2)}$ $^{(3)}$ | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V ₁ < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| I _O | Continuous output current | | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| | | DGG package | | 70 | |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGV package | | 58 | °C/W |
| | | GQL/ZQL package | | 28 | |
| T _{stg} | Storage temperature range | 1 | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

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SCES393B-JUNE 2002-REVISED MARCH 2008

RECOMMENDED OPERATING CONDITIONS⁽¹⁾⁽²⁾⁽³⁾

over operating free-air temperature range (unless otherwise noted)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|-----------------|--------------------------------|---|------------------|------------------|----------------------|------------------------------|------|
| V_{CCA} | Supply voltage | | | | 1.4 | 3.6 | V |
| V_{CCB} | Supply voltage | | | | 1.4 | 3.6 | V |
| | | | 1.4 V to 1.95 V | | $V_{CCI} 	imes 0.65$ | | |
| VIH | High-level input voltage | Data inputs | 1.95 V to 2.7 V | | 1.7 | | V |
| | | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.4 V to 1.95 V | | | $V_{\text{CCI}} \times 0.35$ | |
| V _{IL} | Low-level input voltage | Data inputs | 1.95 V to 2.7 V | | | 0.7 | V |
| | | | 2.7 V to 3.6 V | | | 0.8 | |
| | | | 1.4 V to 1.95 V | | $V_{CCB} 	imes 0.65$ | | |
| VIH | High-level input voltage | Control inputs (referenced to V _{CCB}) | 1.95 V to 2.7 V | | 1.7 | | V |
| | | (ICICICICICCO IC VCCB) | 2.7 V to 3.6 V | | 2 | | |
| | | _ | 1.4 V to 1.95 V | | | $V_{\text{CCB}} \times 0.35$ | |
| V _{IL} | Low-level input voltage | Control inputs (referenced to V _{CCB}) | 1.95 V to 2.7 V | | | 0.7 | V |
| | | (.e.e.enced to TCCB) | 2.7 V to 3.6 V | | | 0.8 | |
| VI | Input voltage | | | | 0 | 3.6 | V |
| V | Output voltage | Active state | | | 0 | V _{cco} | V |
| Vo | Oulput voltage | 3-state | | | 0 | 3.6 | v |
| | | | | 1.4 V to 1.6 V | | -2 | |
| | High-level output current | | | 1.65 V to 1.95 V | | -4 | mA |
| I _{OH} | | | | 2.3 V to 2.7 V | | -8 | ШA |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.4 V to 1.6 V | | 2 | |
| 1 | Low-level output current | | | 1.65 V to 1.95 V | | 4 | mA |
| I _{OL} | | | | 2.3 V to 2.7 V | | 8 | ШA |
| | | | | 3 V to 3.6 V | | 12 | |
| Δt/Δv | Input transition rise or fall | rate | | | | 5 | ns/V |
| Τ _Α | Operating free-air temperation | ature | | | -40 | 85 | °C |

(1)

(2) (3)

 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the data output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SCES393B-JUNE 2002-REVISED MARCH 2008

ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾

over operating free-air temperature range (unless otherwise noted)

| P | ARAMETER | TEST COND | ITIONS | V _{CCA} | V _{CCB} | MIN | TYP ⁽³⁾ | MAX | UNI |
|---------------------|----------------|---|--------------------------|------------------|------------------|-----------------|--------------------|-------|-----|
| | | I _{OH} = -100 μA | $V_{I} = V_{IH}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | $V_{CCO} - 0.2$ | | | |
| | | $I_{OH} = -2 \text{ mA}$ | $V_{I} = V_{IH}$ | 1.4 V | 1.4 V | 1.05 | | | |
| V _{он} | | $I_{OH} = -4 \text{ mA}$ | $V_{I} = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | V |
| | | I _{OH} =8 mA | $V_{I} = V_{IH}$ | 2.3 V | 2.3 V | 1.75 | | | |
| | | I _{OH} = -12 mA | $V_{I} = V_{IH}$ | 3 V | 3 V | 2.3 | | | |
| | | I _{OH} = 100 μA | $V_{I} = V_{IL}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | | | 0.2 | |
| | | I _{OH} = 2 mA | $V_{I} = V_{IL}$ | 1.4 V | 1.4 V | | | 0.35 | |
| V _{OL} | | I _{OH} = 4 mA | $V_{I} = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | V |
| | | I _{OH} = 8 mA | $V_I = V_{IL}$ | 2.3 V | 2.3 V | | | 0.55 | |
| | | I _{OH} = 12 mA | $V_I = V_{IL}$ | 3 V | 3 V | | | 0.7 | |
| I | Control inputs | $V_I = V_{CCB}$ or GND | | 1.4 V to 3.6 V | 3.6 V | | | ±2.5 | μA |
| | | V _I = 0.49 V | | 1.4 V | 1.4 V | | 11 | | |
| (4) | | V _I = 0.57 V | | 1.65 V | 1.65 V | 25 | | | Ι. |
| BHL ⁽⁴⁾ | | V _I = 0.7 V | | 2.3 V | 2.3 V | 45 | | | μA |
| | | V _I = 0.8 V | | 3 V | 3 V | 75 | | | |
| | | V _I = 0.49 V | | 1.4 V | 1.4 V | | -11 | | |
| (5) | | V ₁ = 0.57 V | | 1.65 V | 1.65 V | -25 | | | 1. |
| внн ⁽⁵⁾ | | V ₁ = 0.7 V | | 2.3 V | 2.3 V | -45 | | | μA |
| | | V _I = 0.8 V | | 3 V | 3 V | -75 | | | |
| | | | | 1.6 V | 1.6 V | 100 | | | |
| (6) | | | | 1.95 V | 1.95 V | 200 | | | |
| BHLO ⁽⁶⁾ | | $V_I = 0$ to V_{CC} | | 2.7 V | 2.7 V | 300 | | | μA |
| | | | | 3.6 V | 3.6 V | 525 | | | |
| | | | | 1.6 V | 1.6 V | -100 | | | |
| (7) | | | | 1.95 V | 1.95 V | -200 | | | 1. |
| внно ⁽⁷⁾ | | $V_{I} = 0$ to V_{CC} | | 2.7 V | 2.7 V | -300 | | | μA |
| | | | | 3.6 V | 3.6 V | -525 | | | |
| | A port | | | 0 V | 0 to 3.6 V | | | ±10 | |
| off | B port | - V _I or V _O = 0 to 3.6 V | | 0 to 3.6 V | 0 V | | | ±10 | μA |
| | A or B ports | | $\overline{OE} = V_{IH}$ | 3.6 V | 3.6 V | | | ±12.5 | |
| oz ⁽⁸⁾ | B port | $V_0 = V_{CCO}$ or GND, | $\overline{OE} = don't$ | 0 V | 3.6 V | | | ±12.5 | μA |
| | A port | $V_{I} = V_{CCI} \text{ or GND}$ | care | 3.6 V | 0 V | | | ±12.5 | |
| | 1 | | 1 | 1.6 V | 1.6 V | | | 20 | |
| | | | | 1.95 V | 1.95 V | | | 20 | |
| | | | | 2.7 V | 2.7 V | | | 30 | 1. |
| ССА | | $V_{I} = V_{CCI} \text{ or GND},$ | $I_{O} = 0$ | 0 V | 3.6 V | | | -40 | μA |
| | | | 3.6 V | 0 V | | | 40 | - | |
| | | | | 3.6 V | 3.6 V | | | 40 | 1 |

(1)

- V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port. (2)
- All typical values are at $T_A = 25^{\circ}C$. (3)

- (5) The bus-hold circuit can source at least the minimum high sustaining current at VIH min. IBHH should be measured after raising VIN to VCC and then lowering it to VIH min.
- An external driver must source at least IBHLO to switch this node from low to high. (6)
- An external driver must sink at least IBHHO to switch this node from high to low. (7)For I/O ports, the parameter I_{OZ} includes the input leakage current.
- (8)

The bus-hold circuit can sink at least the minimum low sustaining current at VIL max. IBHL should be measured after lowering VIN to (4) GND and then raising it to VIL max.



SCES393B-JUNE 2002-REVISED MARCH 2008

ELECTRICAL CHARACTERISTICS (continued)

over operating free-air temperature range (unless otherwise noted)

| I | PARAMETER | TEST CONDITIONS | V _{CCA} | V _{CCB} | MIN TYP ⁽³⁾ MAX | UNIT |
|------|----------------|---|------------------|------------------|----------------------------|------|
| | | | 1.6 V | 1.6 V | 20 | |
| | | | 1.95 V | 1.95 V | 20 | |
| | | | 2.7 V | 2.7 V | 30 | |
| ICCB | | $V_{I} = V_{CCI} \text{ or } GND, \qquad I_{O} = 0$ | 0 V | 3.6 V | 40 | μA |
| | | | 3.6 V | 0 V | -40 | |
| | | | 3.6 V | 3.6 V | 40 | |
| Ci | Control inputs | V _I = 3.3 V or GND | 3.3 V | 3.3 V | 4 | pF |
| Cio | A or B ports | $V_0 = 3.3 \text{ V or GND}$ | 3.3 V | 3.3 V | 5 | pF |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | FROM TO (INPUT) (OUTPUT) | | 1.5 V V | V _{ССВ} = ± 0.1 | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|---------------------|---------|-----------------------------|-----|------------|-----------------------------|-----|-------------------------------------|--------|-------------------------------------|-----|------|
| | (INPUT) | (001901) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| + | А | В | 1.7 | 6.7 | 1.9 | 6.3 | 1.8 | 5.5 | 1.7 | 5.8 | 20 |
| t _{pd} | В | А | 1.8 | 6.8 | 2.2 | 7.4 | 2.1 | 7.6 | 2.1 | 7.3 | ns |
| + | OE | А | 2.5 | 8.4 | 2.4 | 7.4 | 2.1 | 5.2 | 1.9 | 4.2 | 20 |
| t _{en} | UE | В | 2.1 | 9 | 2.9 | 9.8 | 3.2 | 10 | 3 | 9.8 | ns |
| t _{dis} OE | A | 2.2 | 6.9 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | 20 | |
| | 0E | В | 2.1 | 7.1 | 2.3 | 6.4 | 1.7 | 5.15.1 | 1.6 | 4.8 | ns |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CCA} = 1.8 V ± 0.15 V (see Figure 2)

| PARAMETER | FROM | FROM TO (INPUT) (OUTPUT) – | | V _{CCB} = 1.5 V V _{CCB} = 1.8 V ± 0.1 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT | |
|------------------|----------------------------|-------------------------------|-----|---|-----|-------------------------------------|-----|-------------------------------------|-----|------|----|
| | (INFUT) | (001F01) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | А | В | 1.7 | 6.7 | 1.8 | 6 | 1.7 | 4.7 | 1.6 | 4.3 | 20 |
| t _{pd} | В | A | 1.4 | 5.5 | 1.8 | 6 | 1.8 | 5.8 | 1.8 | 5.5 | ns |
| + | | A | 2.6 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | 20 |
| t _{en} | ŌĒ | В | 1.8 | 7.6 | 2.6 | 7.7 | 2.6 | 7.6 | 2.6 | 7.4 | ns |
| | t _{dis} <u>OE</u> | A | 2.3 | 7 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | 20 |
| t _{dis} | UE | В | 1.8 | 7 | 2.5 | 6.3 | 1.8 | 4.7 | 1.7 | 4.4 | ns |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO | V _{CCB} = 1.5 V ± 0.1 V | | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|---------------------|---------|----------|-------------------------------------|-----|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| • | А | В | 1.6 | 6 | 1.8 | 5.6 | 1.5 | 4 | 1.4 | 3.4 | 20 |
| t _{pd} | В | А | 1.3 | 4.6 | 1.7 | 4.4 | 1.5 | 4 | 1.4 | 3.7 | ns |
| | ŌĒ | A | 3.1 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | ~~ |
| t _{en} | UE | В | 1.7 | 5.7 | 2.2 | 5.5 | 2.2 | 5.3 | 2.2 | 5.1 | ns |
| t _{dis} OE | А | 2.4 | 7 | 3 | 6.1 | 1.4 | 3.6 | 1.2 | 3 | ~~ | |
| | UE | В | 1.2 | 5.8 | 1.9 | 5 | 1.4 | 3.6 | 1.3 | 3.3 | ns |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 2)

| PARAMETER | FROM TO (INPUT) (OUTPUT) | | | V _{CCB} = 1.5 V ± 0.1 V | | V _{CCB} = 1.8 V ± 0.15 V | | 2.5 V 2 V | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|------------------|-----------------------------|----------|-----|-------------------------------------|-----|--------------------------------------|-----|--------------|-------------------------------------|-----|------|
| | (INFOT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | A | В | 1.5 | 5.9 | 1.7 | 5.4 | 1.5 | 3.7 | 1.4 | 3.1 | ~~ |
| t _{pd} | В | А | 1.3 | 4.5 | 1.6 | 3.8 | 1.5 | 3.3 | 1.4 | 3.1 | ns |
| | ŌĒ | А | 2.6 | 8.3 | 2.5 | 7.4 | 2.2 | 5.2 | 1.9 | 4.1 | ~~ |
| Len | UE | В | 1.6 | 4.9 | 2 | 4.5 | 2 | 4.3 | 1.9 | 4.1 | ns |
| | t _{dis} <u>OE</u> | А | 2.3 | 7 | 3 | 6 | 1.3 | 3.5 | 1.2 | 3.5 | |
| t _{dis} | UE | В | 1.3 | 6.9 | 2.1 | 5.5 | 1.6 | 3.8 | 1.5 | 3.5 | ns |

OPERATING CHARACTERISTICS

 V_{CCA} and V_{CCB} = 3.3 V, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | TYP | UNIT | |
|---|---|------------------|-----------------------------------|------|------------|
| | Power dissipation capacitance per transceiver, | Outputs enabled | | 14 | |
| C _{pdA} (V _{CCA}) | A-port input, B-port output | Outputs disabled | | 7 | - 5 |
| | Power dissipation capacitance per transceiver, | Outputs enabled | $-C_{L} = 0, f = 10 \text{ MHz}$ | 20 | pF |
| | B-port input, A-port output | Outputs disabled | | 7 | |
| С _{рdB} (V _{CCB}) | Power dissipation capacitance per transceiver, A-port input, B-port output | Outputs enabled | | 20 | |
| | | Outputs disabled | | 7 | - F |
| | Power dissipation capacitance per transceiver, | Outputs enabled | $-C_{L} = 0, f = 10 \text{ MHz}$ | 14 | pF |
| | B-port input, A-port output | Outputs disabled | | 7 | |

Output Description

The DOCTM circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical V_{OL} vs I_{OL} and V_{OH} vs I_{OH} curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, AVC Logic Family Technology and Applications, literature number SCEA006, and Dynamic Output Control (DOCTM) Circuitry Technology and Applications, literature number SCEA009.

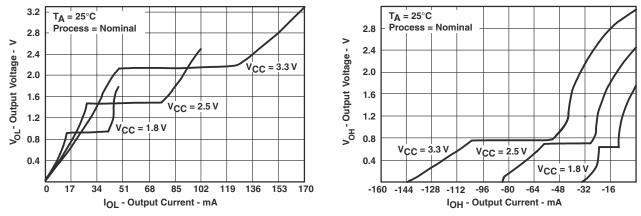
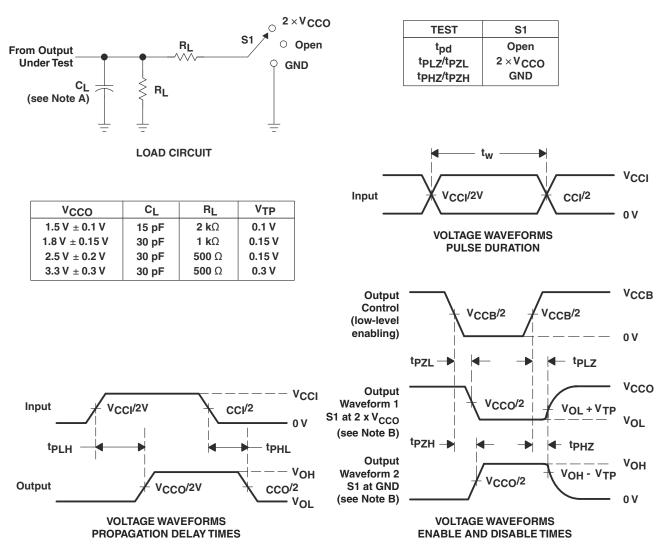


Figure 1. Typical Output Voltage vs Output Current



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PARAMETER MEASUREMENT INFORMATION

Figure 2. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ | MSL rating/ | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
| | (1) | (2) | | | (3) | Ball material | Peak reflow | | (6) |
| | | | | | | (4) | (5) | | |
| 74AVCBH164245GRG4 | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCBH164245 |
| 74AVCBH164245GRG4.B | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCBH164245 |
| SN74AVCBH164245GR | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCBH164245 |
| SN74AVCBH164245GR.B | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCBH164245 |
| SN74AVCBH164245VR | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WBH4245 |
| SN74AVCBH164245VR.B | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WBH4245 |

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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PACKAGE OPTION ADDENDUM

17-Jun-2025



Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| 74AVCBH164245GRG4 | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AVCBH164245GR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AVCBH164245VR | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

24-Jul-2025



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74AVCBH164245GRG4 | TSSOP | DGG | 48 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74AVCBH164245GR | TSSOP | DGG | 48 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74AVCBH164245VR | TVSOP | DGV | 48 | 2000 | 353.0 | 353.0 | 32.0 |

MECHANICAL DATA

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not

- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-153.



DGG0048A

DGG0048A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DGG0048A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate

design recommendations. 8. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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